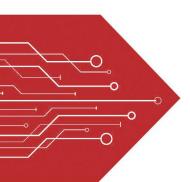
MSKSEMI















ESD

TVS

TSS

MOV

GDT

PLED

Broduct data sheet





S0T-89

概述:

AMS1117 是一款低压差的线性稳压器。

AMS1117-XXX

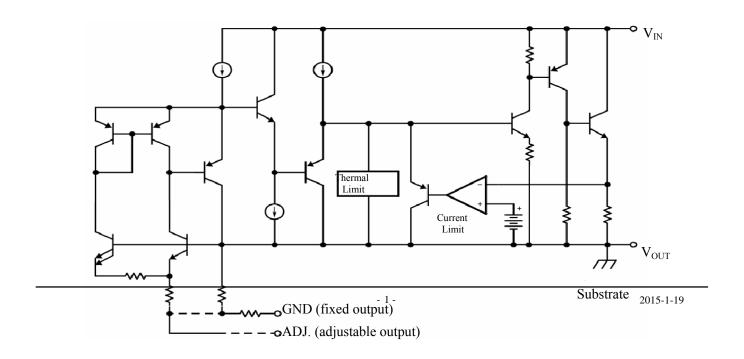
特点:

- 包括三端可调输出和固定电压输出版本 (固定电压包括 1.2V,1.8V, 2.5V, 3.3V, 5V等, 其他电压规格可根据用户定制)
- 最大输出电流为 1A
- 输出电压精度高达±2%
- 稳定工作电压范围为高达 12V
- 电压线性度为 0.2%
- 负载线性度为 0.4%
- 环境温度: Ta的范围是 0℃~125℃

用途:

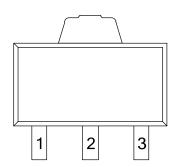
- 计算机主板、显卡
- LCD 监视器及 LCD TV
- DVD 解码板
- ADSL 等设备
- 开关电源的后级稳压

功能图:





引脚排列图:



SOT-89

引脚定义:

引脚号	符号	定义
1	GND	接地脚
2	Vout	输出端
3	Vin	输入端

固定电 压型

引脚号	符号	定义
1	Adj.	可调端
2	Vout	输出端
3	Vin	输入端

可调电 压型

极限值:

参 数 名 称	符号	数 值	单位
最大输入电压	Vin	18	V
最大节温	TJ	125	°C
最大环境温度	TA	125	°C
贮存温度	Ts	-65~ +150	°C
焊接温度和时间		300°C,10S	

推荐工作条件:

名称	最小	推荐	最大	单位
输入电压范围			15	V
工作环境温度	0		125	°C

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主要参数和工作特性:

Tj=25°C

						1j-23
参数	参数说明	条件	最小值	典型值	最大值	单位
Vref	参考电压	lout=10mA, Vin-Vout=2V 10mA≤lout≤1A ,1.5V≤Vin-Vout≤10V	1.225	1.25	1.275	V
		AMS1117-1.50V 10mA≤lout≤1A ,3.0V≤Vin≤10V	1.470	1.5	1.530	V
Vout	输出电压	AMS1117-1.80V 10mA≤lout≤1A ,3.25V≤Vin≤10V	1.764	1.80	1.836	V
		AMS1117-2.50V 10mA≤lout≤1A ,3.9 V≤Vin≤10V	2.45	2.50	2.55	٧
		AMS1117-3.3V 10mA≤lout≤1A , 5.3 V≤Vin≤12V	3.235	3.3	3.365	V
		AMS1117-5V 10mA≤lout≤1A , 6.5V≤Vin≤12V	4.9	5	5.1	V
		AMS1117-ADJ lout=10mA, V≪Vin-Vout≪10V		5	18	mV
		AMS1117-1.5V lout=10mA, 2.75V≪Vin≪10V		5	18	mV
ΔVout	电压线性度	AMS1117-1.8V lout=10mA, 3.25 V≪Vin≪10V		5	18	mV
		AMS1117-2.50V lout=10mA, 3.9 V≤Vin≤10V		5	18	mV
		AMS1117-3.3V lout=10mA, 5.3 V≪Vin≪12V		9	18	mV
		AMS1117-5V lout=10mA,6.5V≤Vin≤12V		9	18	mV
ΔVout	名 去 经 件 亩	AMS1117-ADJ Vin=3.25V, 10mA≤lout≤1A		9	18	mV
Avout	负载线性度	AMS1117-1.5V Vin = 3.25V, 10mA≤lout≤1A		9	18	mV

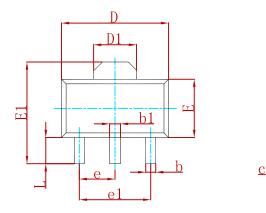


主要参数和工作特性:

		AMS1117-1.8V Vin = 3.25V, 10mA≤lout≤1A	10	18	mV
		AMS1117-2.5V Vin = 4.5 V, 10mA≤lout≤1A	10	18	mV
		AMS1117-3.3V Vin=5.3V, 0≤lout≤1A	12	20	mV
		AMS1117-5V Vin=6.5V, 0≤lout≤1A	12	20	mV
Vin-Vout	最小输入输出电压差	ΔVout, ΔVref,=1%, lout=1A		1.4	V
llimit	最小负载电流	AMS1117-ADJ		10	mA
		AMS1117-ADJ Vin=4.0V		12	mA
		AMS1117-1.5V,Vin=4.8V		12	mA
Iq	静态电流	AMS1117-1.8V,Vin = 4.8V		12	mA
14	₩ 50 H 70L	AMS1117-2.5V,Vin = 4.8V		12	mA
		AMS1117-3.3V,Vin = 4.8V		12	mA
		AMS1117-5.0V,Vin = 4.8V		12	mA

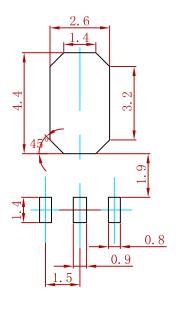


PACKAGE MECHANICAL DATA



Symbol	Dimensions In Millimeters		Dimension	s In Inches
Symbol	Min	Max	Min	Max
Α	1.400	1.600	0.055	0.063
b	0.320	0.520	0.013	0.020
b1	0.400	0.580	0.016	0.023
С	0.350	0.440	0.014	0.017
D	4.400	4.600	0.173	0.181
D1	1.550	1.550 REF.		REF.
E	2.300	2.600	0.091	0.102
E1	3.940	4.250	0.155	0.167
е	1.500	TYP.	0.060 TYP.	
e1	3.000	TYP.	0.118	TYP.
L	0.900	1.200	0.035	0.047

Suggested Pad Layout



Note:

- 1.Controlling dimension:in millimeters.
- 2.General tolerance:±0.05mm.
- 3. The pad layout is for reference purposes only.

REEL SPECIFICATION

P/N	PKG	QTY
AMS1117-XXX	SOT-89	1000



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